Device Modeling Report

COMPONENTS: Power MOSFET (Professional)
PART NUMBER: 2SK2508
MANUFACTURER: TOSHIBA
Body Diode (Professional) / ESD Protection Diode

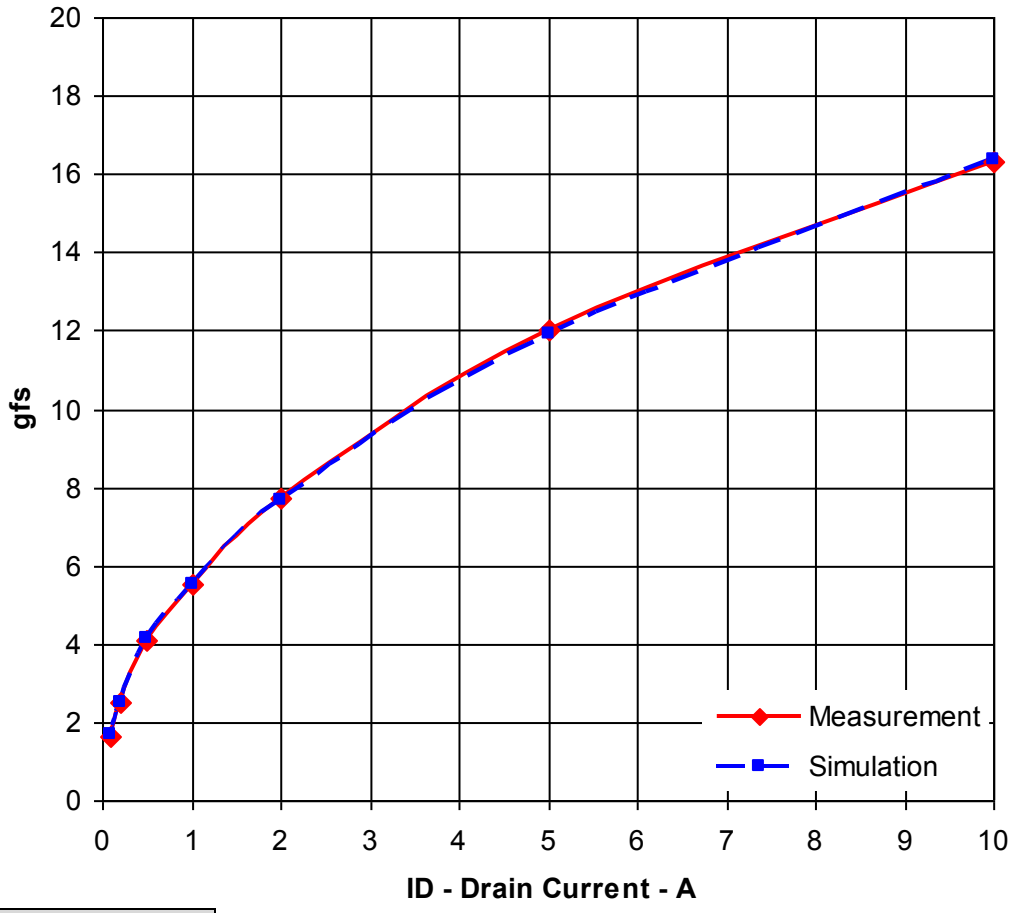
Bee Technologies Inc.

MOSFET MODEL

PSpice model parameter	Model description
LEVEL	
L	Channel Length
W	Channel Width
KP	Transconductance
RS	Source Ohmic Resistance
RD	Ohmic Drain Resistance
VTO	Zero-bias Threshold Voltage
RDS	Drain-Source Shunt Resistance
TOX	Gate Oxide Thickness
CGSO	Zero-bias Gate-Source Capacitance
CGDO	Zero-bias Gate-Drain Capacitance
CBD	Zero-bias Bulk-Drain Junction Capacitance
MJ	Bulk Junction Grading Coefficient
PB	Bulk Junction Potential
FC	Bulk Junction Forward-bias Capacitance Coefficient
RG	Gate Ohmic Resistance
IS	Bulk Junction Saturation Current
N	Bulk Junction Emission Coefficient
RB	Bulk Series Resistance
PHI	Surface Inversion Potential
GAMMA	Body-effect Parameter
DELTA	Width effect on Threshold Voltage
ETA	Static Feedback on Threshold Voltage
THETA	Mobility Modulation
KAPPA	Saturation Field Factor
VMAX	Maximum Drift Velocity of Carriers
XJ	Metallurgical Junction Depth
UO	Surface Mobility

Transconductance Characteristic

Circuit Simulation Result

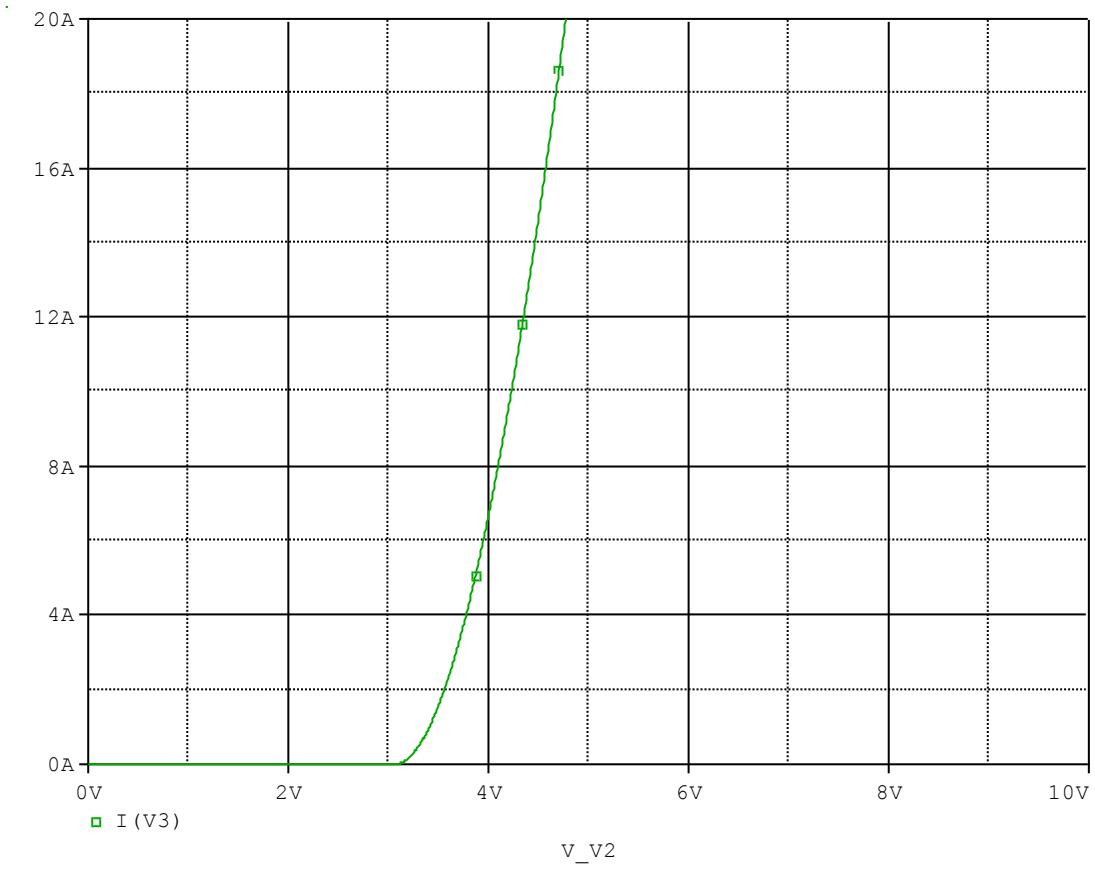


Comparison table

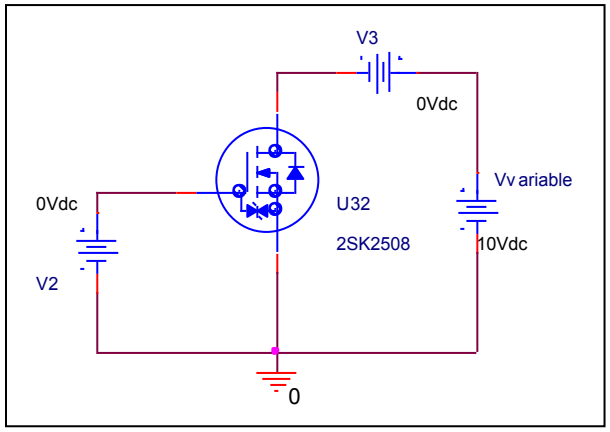
Id(A)	gfs		Error(%)
	Measurement	Simulation	
0.1	1.650	1.667	1.030
0.2	2.500	2.500	0.000
0.5	4.100	4.167	1.634
1	5.500	5.500	0.000
2	7.700	7.692	-0.104
5	12.000	11.905	-0.792
10	16.300	16.393	0.571

Vgs-Id Characteristic

Circuit Simulation result

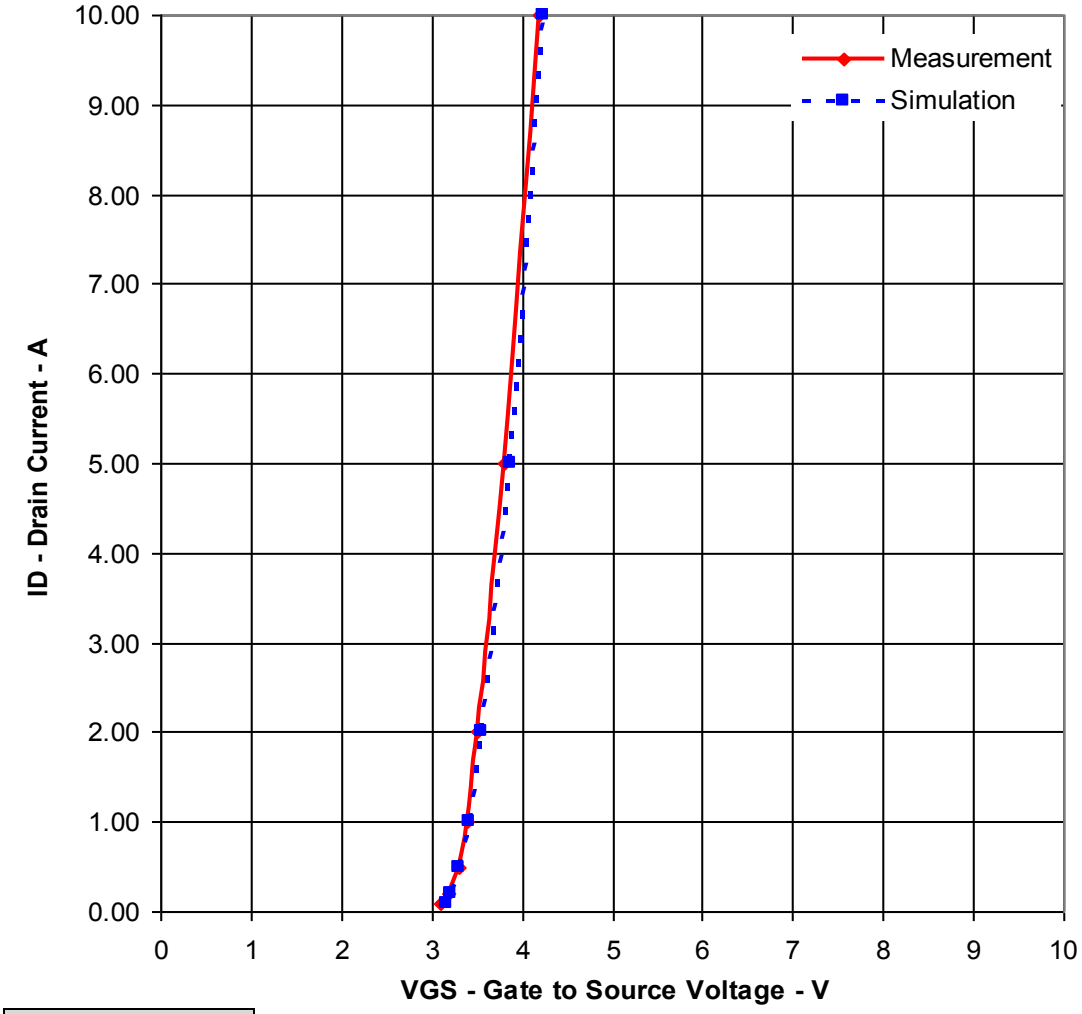


Evaluation circuit



Comparison Graph

Circuit Simulation Result

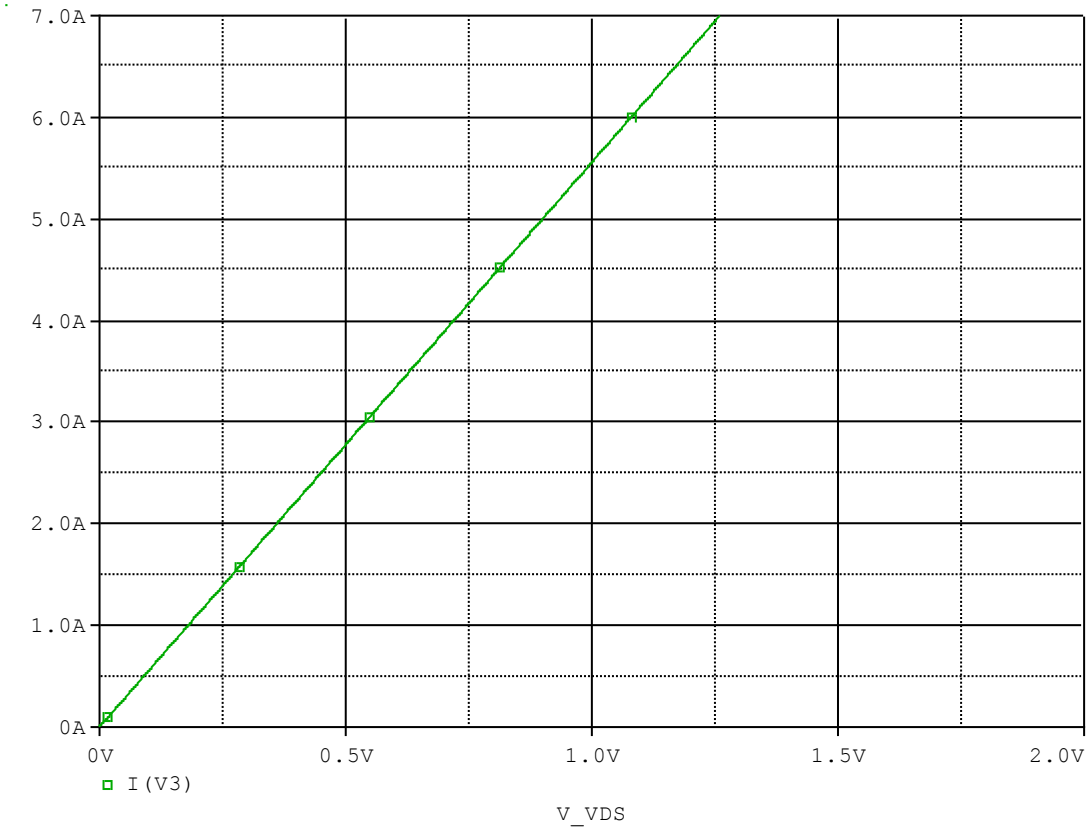


Simulation Result

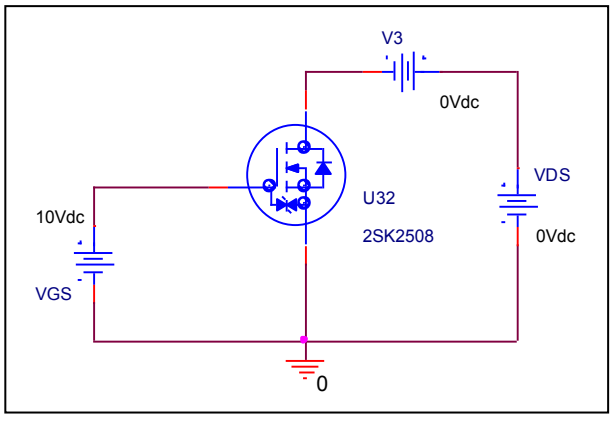
I_D(A)	V_{GS}(V)		Error (%)
	Measurement	Simulation	
0.1	3.100	3.174	2.387
0.2	3.200	3.219	0.594
0.5	3.300	3.310	0.303
1	3.400	3.412	0.353
2	3.500	3.563	1.800
5	3.800	3.873	1.921
10	4.200	4.233	0.786

Rds(on) Characteristic

Circuit Simulation result



Evaluation circuit

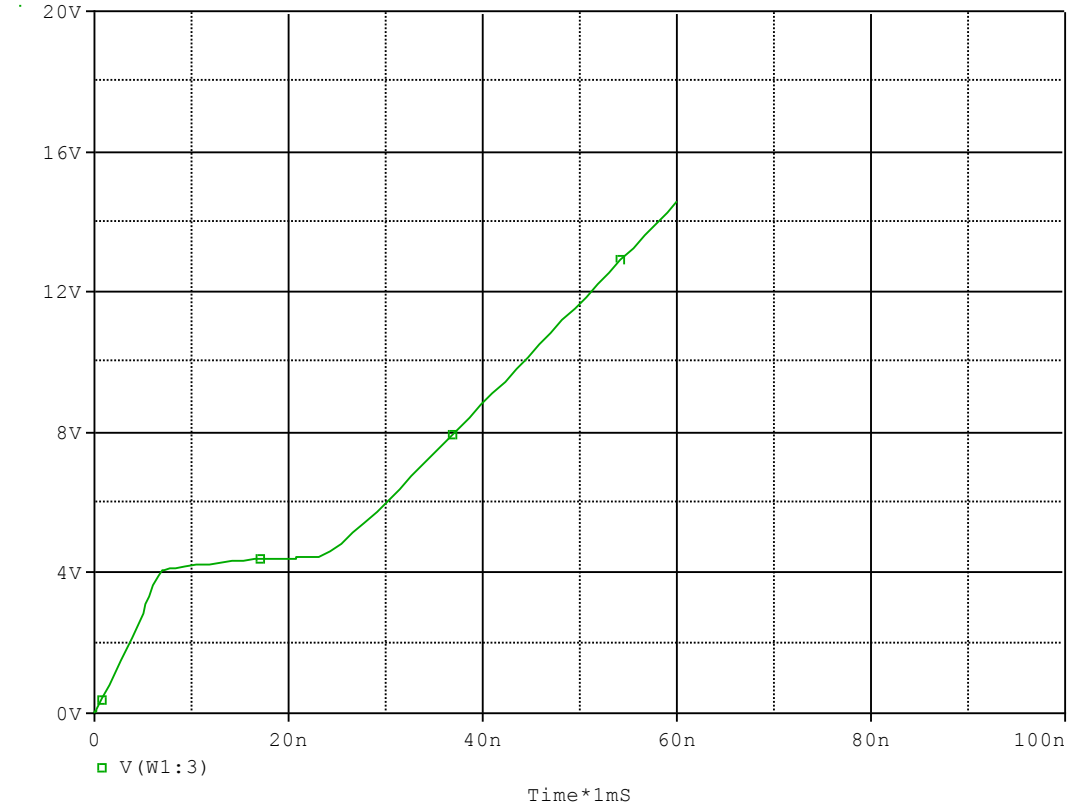


Simulation Result

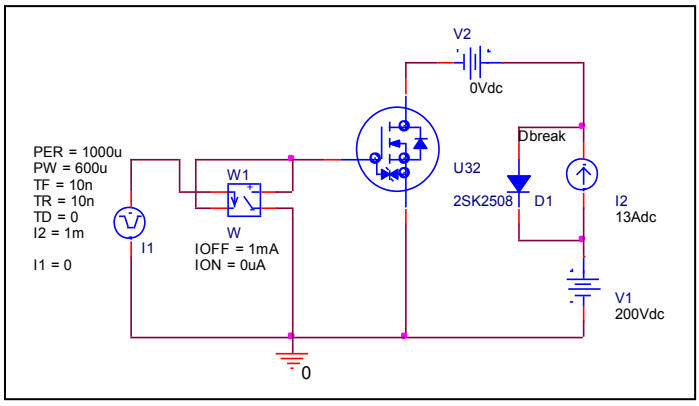
I_D=6.5A, V_{GS}=10V	Measurement		Simulation		Error (%)
R_{DS} (on)	0.180	Ω	0.180	Ω	0

Gate Charge Characteristic

Circuit Simulation result



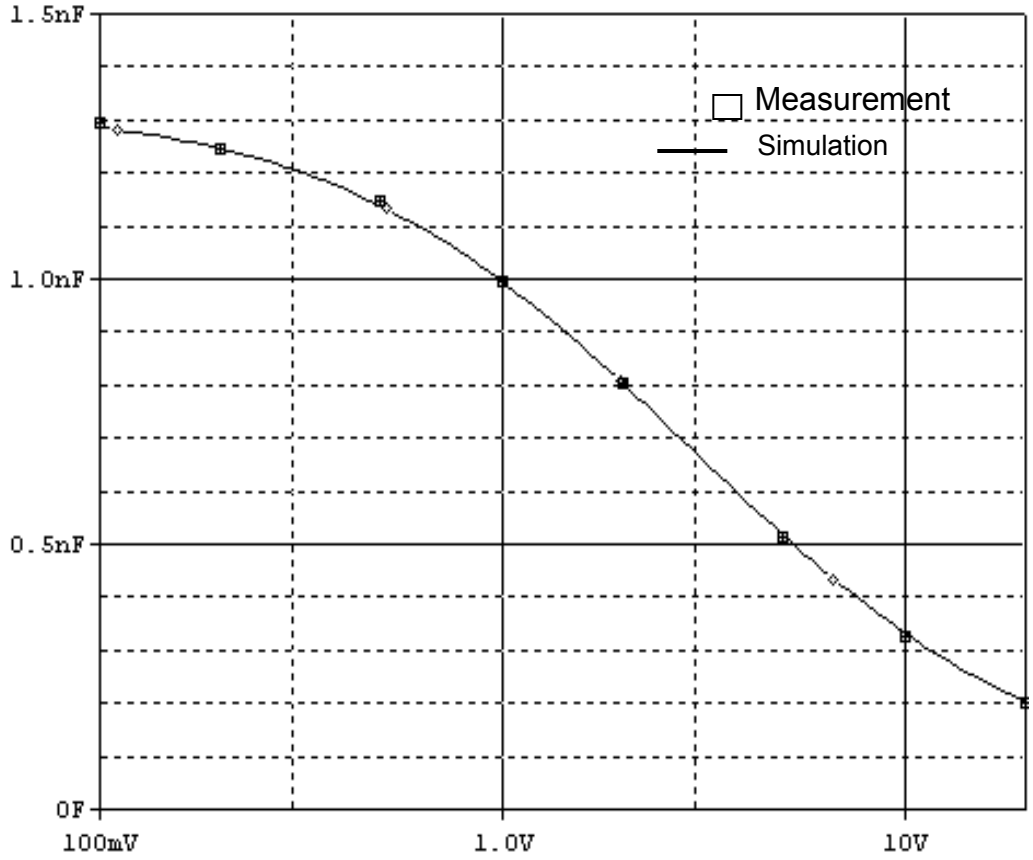
Evaluation circuit



Simulation Result

V_{DD}=200V,I_D=13A ,V_{GS}=10V	Measurement	Simulation	Error (%)
Qgs(nC)	7.000	6.990	-0.143
Qgd(nC)	15.000	14.952	-0.320
Qg	44.000	44.078	0.177

Capacitance Characteristic

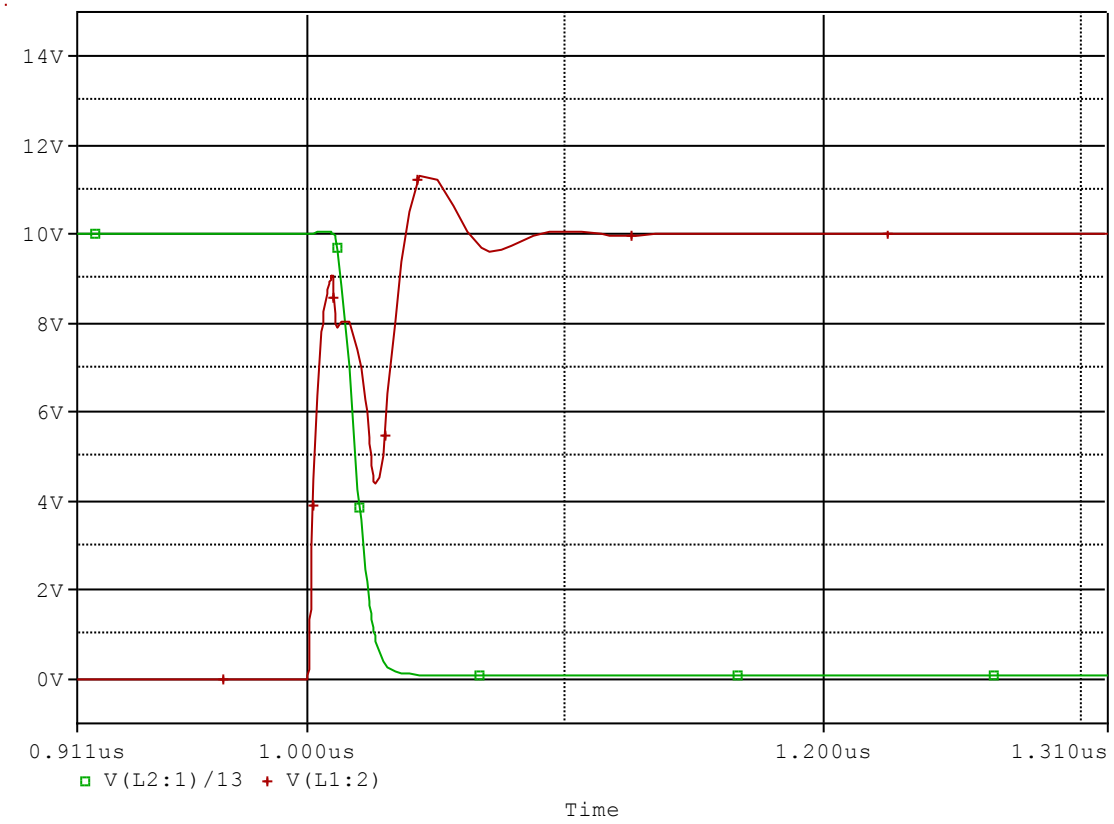


Simulation Result

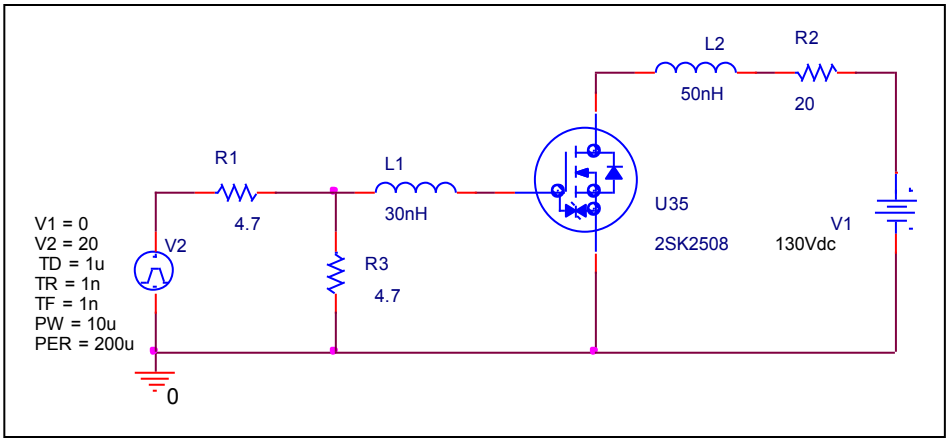
V_{DS}(V)	Cbd(pF)		Error(%)
	Measurement	Simulation	
0.1	1300	1294	-0.462
0.2	1250	1250	0.000
0.5	1150	1148	-0.174
1	1000	1000	0.000
2	810	811	0.123
5	520	520	0.000
10	330	331	0.303
20	206	205	-0.485

Switching Time Characteristic

Circuit Simulation result



Evaluation circuit

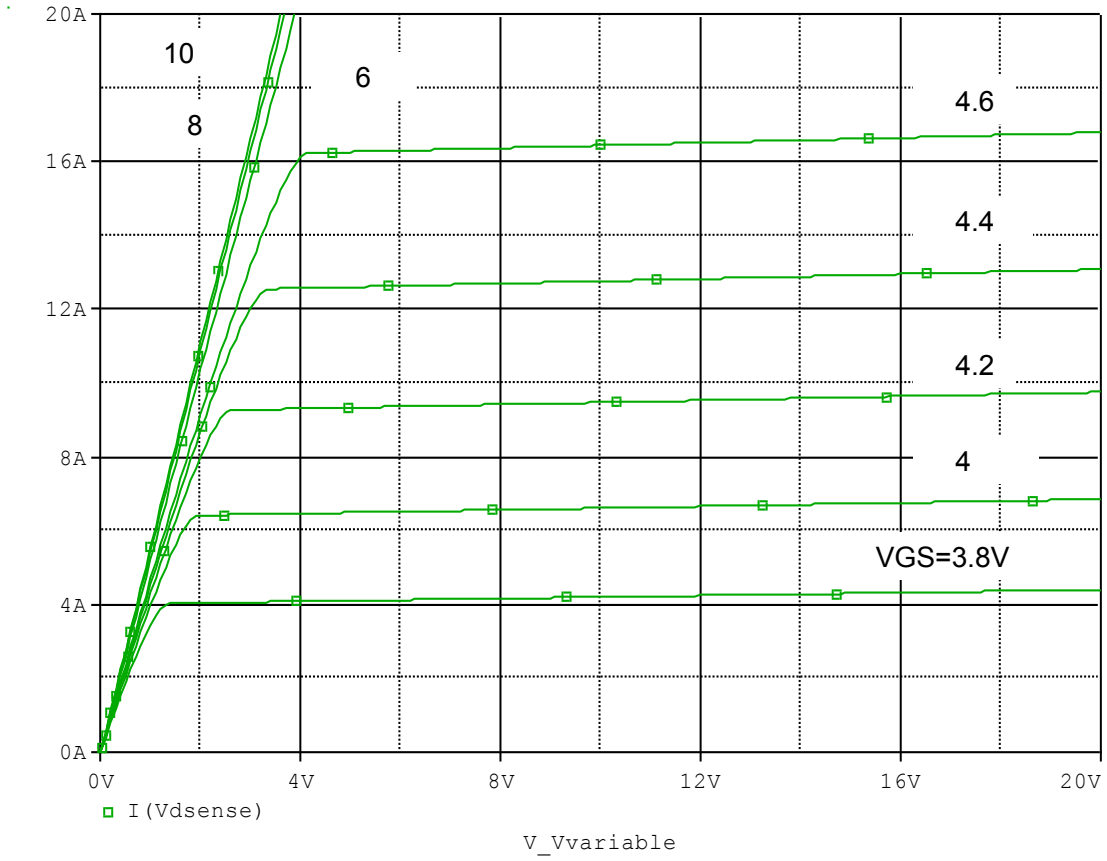


Simulation Result

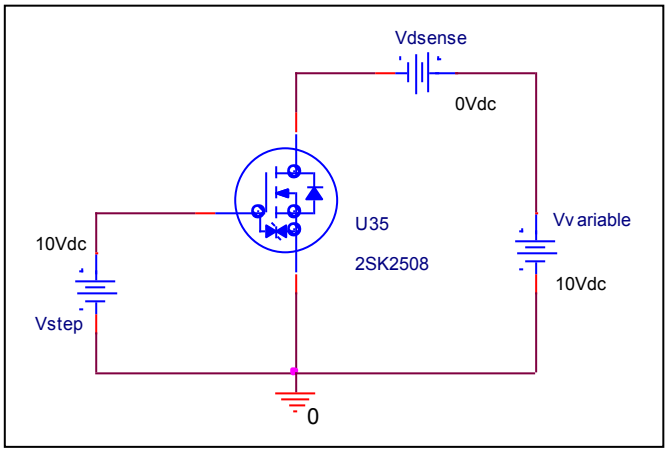
I_D=6.5A, V_{DD}=130V V_{GS}=0/10V	Measurement	Simulation	Error(%)
Ton(ns)	25.000	24.850	-0.600

Output Characteristic

Circuit Simulation result

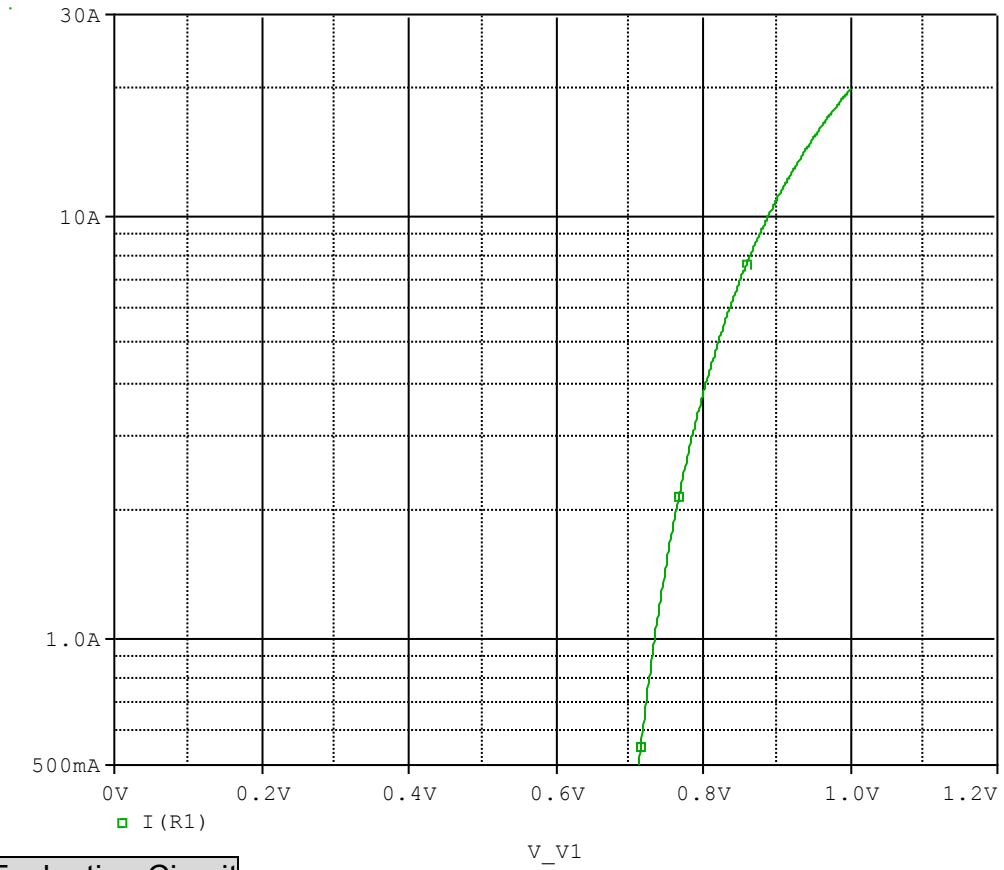


Evaluation circuit

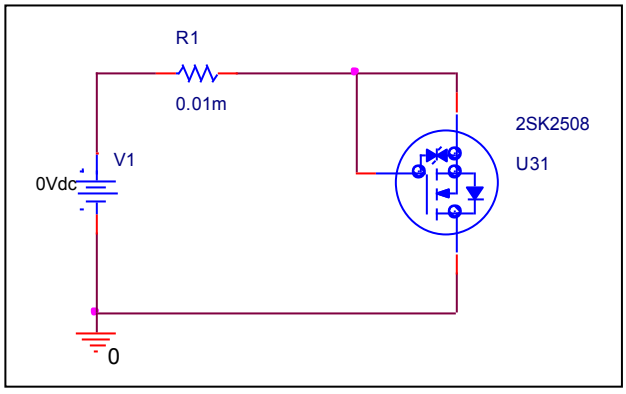


Forward Current Characteristic

Circuit Simulation Result

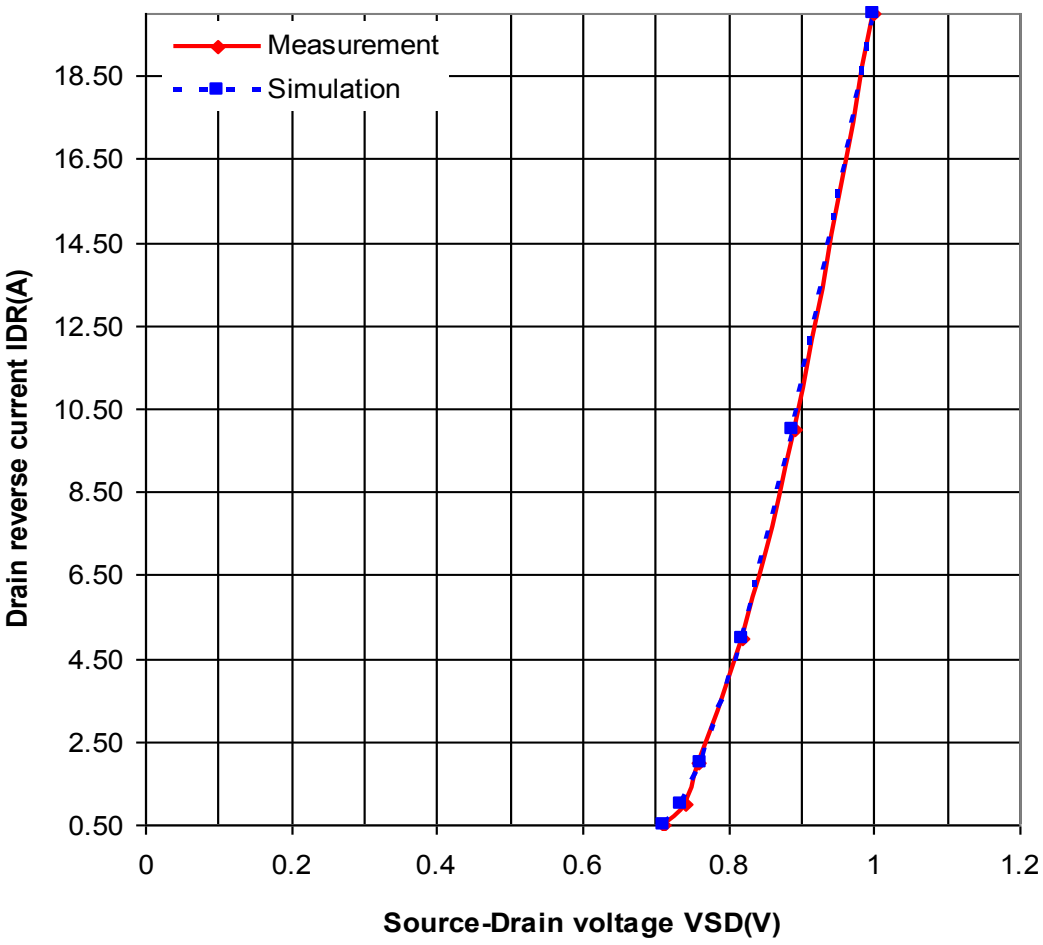


Evaluation Circuit



Comparison Graph

Circuit Simulation Result

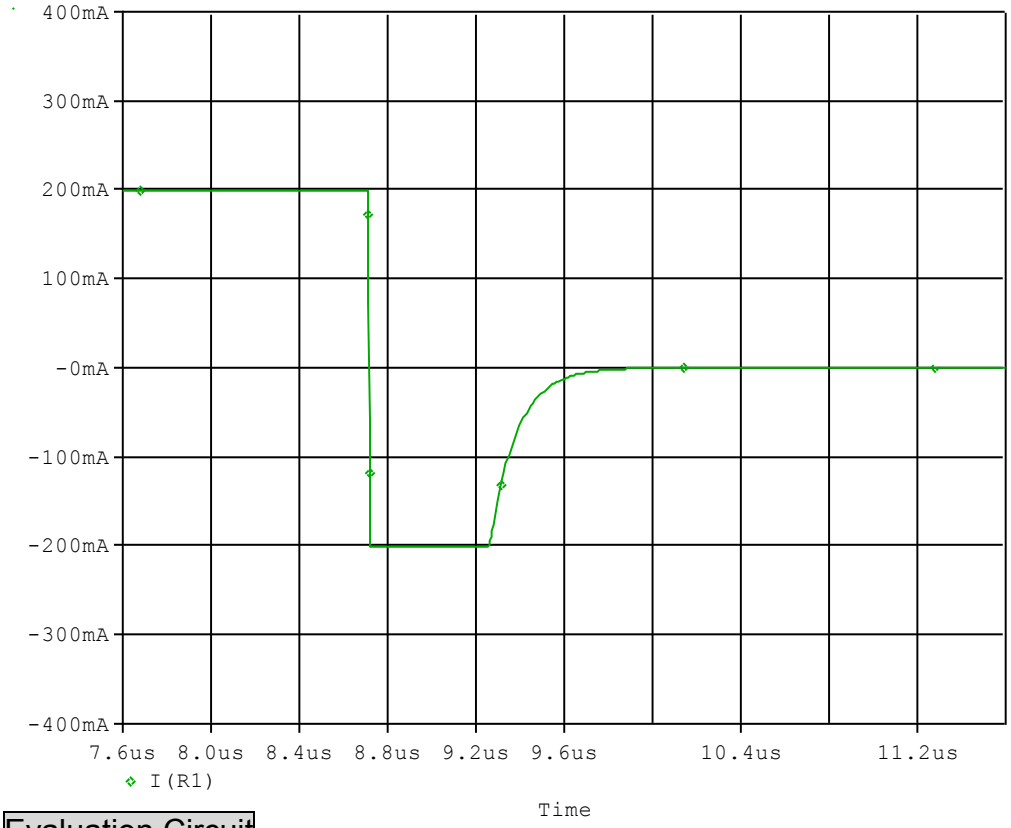


Simulation Result

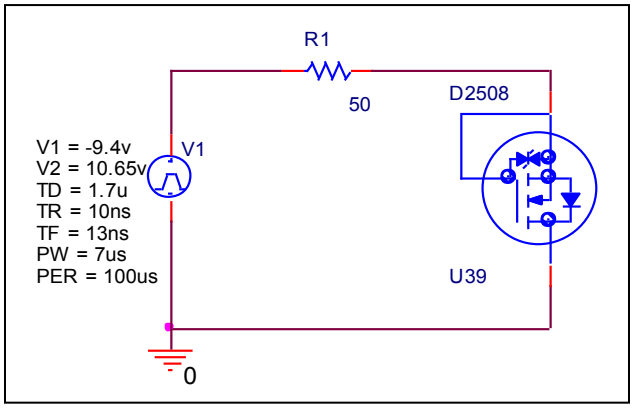
IDR(A)	VSD(V)		%Error
	Measuremen	Simulation	
0.5	0.710	0.712	0.282
1	0.740	0.734	-0.811
2	0.760	0.763	0.395
5	0.820	0.820	0.000
10	0.890	0.889	-0.112
20	1.000	1.000	0.000

Reverse Recovery Characteristic

Circuit Simulation Result



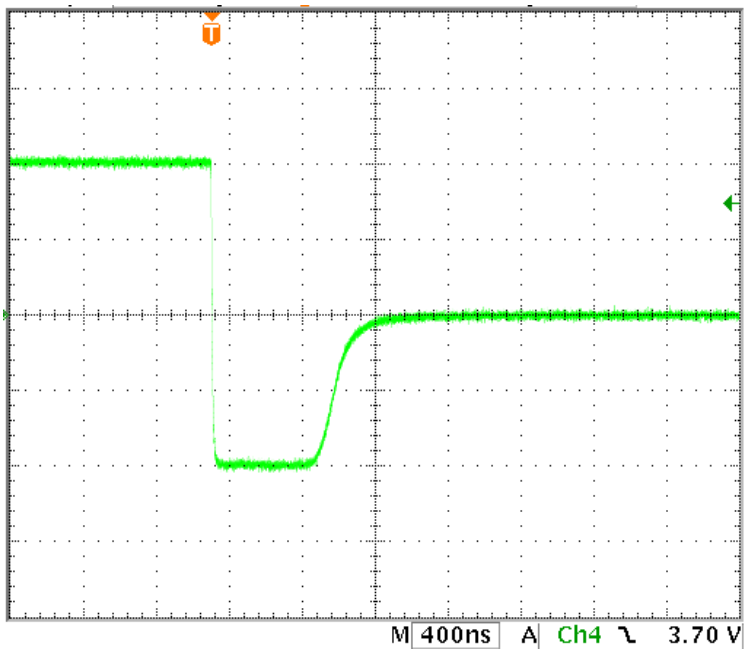
Evaluation Circuit



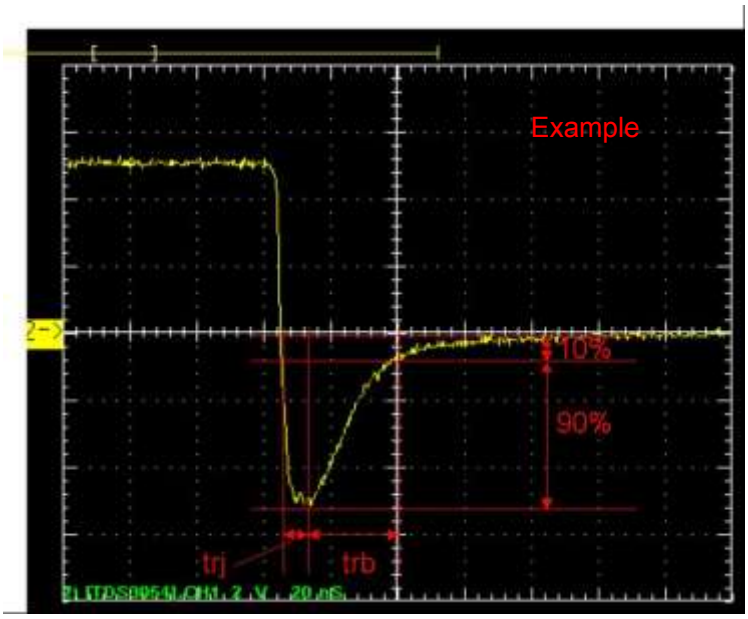
Compare Measurement vs. Simulation

	Measurement	Simulation	Error (%)
Trj(ns)	**535.000**	**536.744**	**0.326**
Trb(ns)	**346.000**	**346.154**	**0.045**
Trr(ns)	**881.50**	**882.898**	**0.159**

Reverse Recovery Characteristic Reference



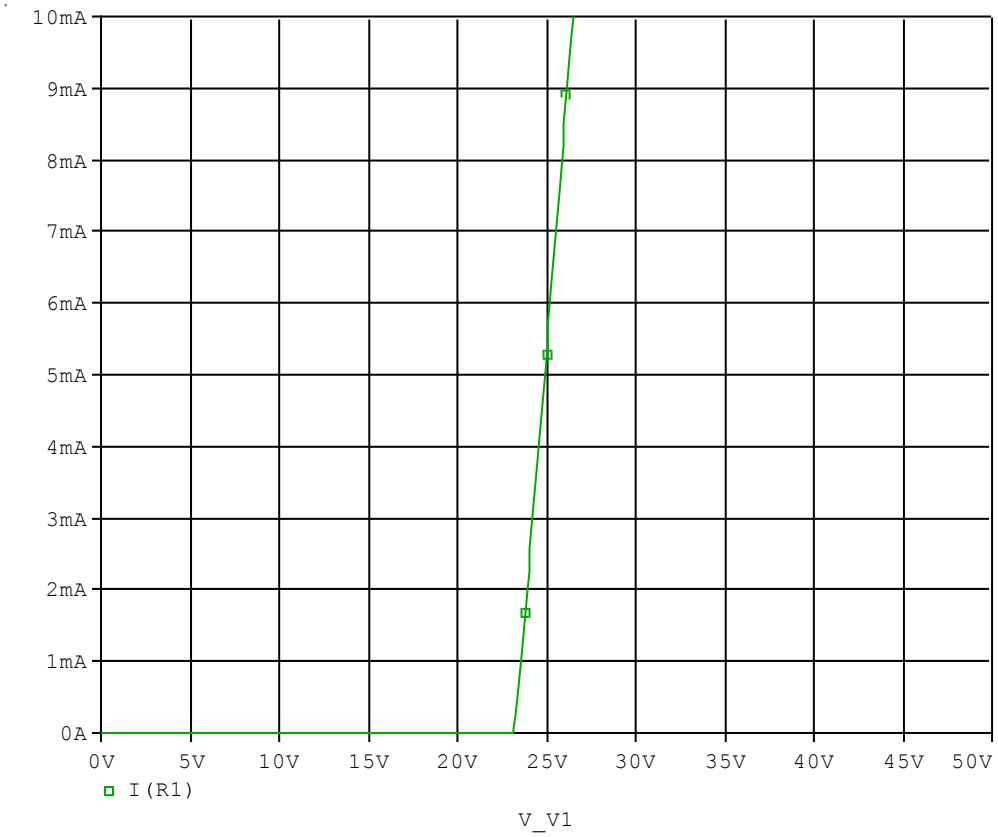
Trj= 535(ns)
Trb=346(ns)
Conditions:Ifwd=Irev=0.2(A),Rl=50



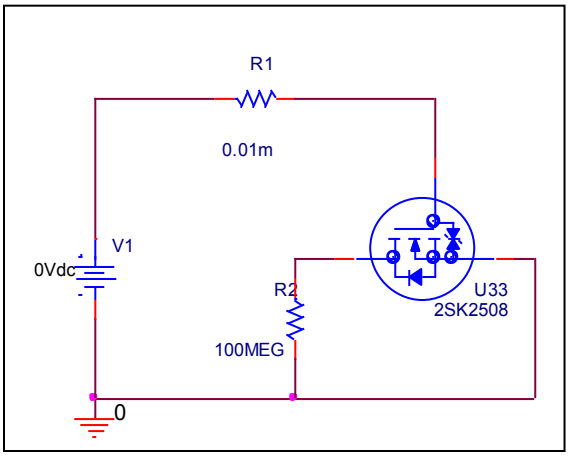
Relation between trj and trb

Zener Voltage Characteristic

Circuit Simulation Result



Evaluation Circuit



Zener Voltage Characteristic Reference